1. The Royal Government of Cambodia (RGC) has received financing from the International Development Association (IDA), World Bank toward the cost of the Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), IDA Credit No. 6221-KH and intends to apply part of the proceeds toward payments under the contract for supply, delivery and installation of Semi-Anechoic Chamber, EMI/EMC test Facility and Seismic Equipment with Accessories. Ref. # MoEYS-HEIP-ICB-G-007.

2. The Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS) now invites sealed Bids from eligible Bidders for supply, delivery and installation of Semi-Anechoic Chamber, EMI/EMC test Facility and Seismic Equipment with Accessories, the final delivery destination: Institute of Technology of Cambodia, the delivery period: 150 calendar days, margin of preference: Not Applicable. # MoEYS-HEIP-ICB-G-007.

The Package consists of 2 lots as listed in the bidding document and the Bidders may bid for one lot or multiple lots. The Bidder evaluation and qualification criteria are included in the bidding document. The bid evaluation will be lot-wise-basis.

3. Bidding will be conducted through international competitive procurement using a Request for Bids (RFB) as specified in the World Bank’s “Procurement Regulations for IPF Borrowers”, dated July 1, 2016; revised in November 2017. (“Procurement Regulations”), and is open to all eligible Bidders as defined in the Procurement Regulations.

4. Interested eligible Bidders may obtain further information from Higher Education Improvement Project (HEIP) and inspect the bidding document at the address given below on 26 November 2021 to 25 January 2022 from 08:00 – 12:00 and 13:30 – 17:30 hours (Cambodia Time), Monday through Friday, except public holidays.

5. A complete set of Bidding Documents in English (Soft Copy) may be obtained with free-of-charge by requesting through email addresses mentioned in para 9. Except for the submission of a written application through email, there shall be no other conditions for obtaining the bidding documents.

6. Bids must be delivered to the address below on or before 9:00 a.m., 26 January 2022 (Cambodia Time). Electronic Bidding will not be permitted. Late Bids will be rejected. Bids will be publicly opened in the presence of the Bidders’ designated representatives and anyone who chooses to attend at the address below on 9:00 a.m., 26 January 2022 (Cambodia Time). Bidders shall not have the option of submitting their Bids electronically.

7. All Bids must be accompanied by a Bid-Securing Declaration.

8. Attention is drawn to the Procurement Regulations requiring the Borrower to disclose information on the successful bidder’s beneficial ownership, as part of the Contract Award Notice, using the Beneficial Ownership Disclosure Form as included in the bidding document.

9. The address (es) referred to above is (are):

(i) Obtaining of information and collection of bidding document at: chey.sith@moeys.gov.kh and copy to luon.monkol@moeys.gov.kh, va.sith.pu@moeys.gov.kh, www.itc.edu.kh/Procurement, www.moeys.gov.kh/en/procurement

(ii) Submitting of bid document, and opening of bids: Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), Project Procurement Unit’s meeting room of MoEYS, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia.

Attention: Mr. Chey Sith, Deputy Director General of Administration and Finance, MoEYS and Chief of Project Procurement Unit, HEIP, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia. Phone: (+855) 023 726 757, 16 478 578, 12 444 401, 12 818 818, Email: chey.sith@moeys.gov.kh and copy to luon.monkol@moeys.gov.kh, va.sith.pu@moeys.gov.kh